

2011 HSC Industrial Technology Electronics Technologies Marking Guidelines

Section I Multiple-choice Answer Key

Question	Answer
1	A
2	С
3	A
4	В
5	D
6	A
7	В
8	D
9	С
10	С



Section II

Question 11

Criteria	Marks
Gives one relevant way in which diodes can be damaged in working	1
electronic circuits	

Question 12

Criteria	Marks
• Outlines reasons why light emitting diodes (LEDs) are replacing filament globes	2
Identifies a relevant property of a LED	1

Question 13

Criteria		Marks
	vides characteristics and features which should be considered when cting a loudspeaker	2
	ches in general terms a property which should be considered when cting a loudspeaker	1

Question 14

Criteria	Marks
• Indicates the main features of the relationship between primary and secondary coils of the transformer	3
• Indicates features of the relationship between the primary and secondary coils of a transformer	
OR	2
• Indicates the main feature of the function of either the primary coil or secondary coil	
Lists/identifies more than ONE appropriate feature of either the primary coil or secondary coil	1

Question 15

Criteria	Marks
• Provides a correct answer (quantum and units) with a sequence of appropriate calculations	3
Provides an incorrect answer with ONE or TWO minor errors in calculations	2
Provides some evidence of which formulae to use	1



Question 16

Criteria	Marks
Provides a correct PCB track layout for the circuit provided with relevant supporting information	4
Provides a limited PCB track layout in the context of the circuit provided with relevant supporting information	3
Provides a limited information PCB track layout	
OR	2
Provides relevant information about PCB track layout	
List/identifies suitable features of PCB track layouts	1

Section III

Question 17 (a)

Criteria	Marks
Provides characteristics and features of personnel issues the company needs to consider when staffing the new facility	5
• Sketches in general terms personnel issues the company needs to consider when staffing the new facility	3–4
Identifies personnel issues the company needs to consider when staffing the new facility	1–2

Question 17 (b)

Criteria	Marks
• Makes the relationships between the factors, other than personnel issues, that affect the viability of a company and the establishment of a facility in a new location evident	9–10
• Identifies factors, other than personnel issues, that affect the viability of a company and provides points for how they relate to the establishment of a facility in a new location	7–8
• Provides characteristics and features of factors, other than personnel issues, that would affect the viability of the company when establishing a facility in a new location	5–6
Sketches in general terms the factors, other than personnel issues, that affect the viability of a company when establishing a facility in a new location	3–4
• Indicates features of factors, other than personnel issues, that affect the viability of a company when establishing a facility in a new location	1–2

Industrial Technology Electronics Technologies

2011 HSC Examination Mapping Grid

Section I

Question	Marks	Content	Syllabus outcomes
1	1	Electrical principles	H4.3
2	1	Electrical principles	H4.3
3	1	Electrical principles	H4.3
4	1	Electrical principles	H3.1, H4.3
5	1	Electrical principles	H4.3, H6.1
6	1	Electrical principles	H3.1
0	1	Graphical communication	113.1
7	1	Electrical principles	H1.2, H3.1, H4.3, H6.1
,	1	Graphical communication	111.2, 113.1, 114.3, 110.1
8	1	Electrical principles	H3.1, H4.3
9	1	Instruments and test equipment	H4.3
9	1	Electrical principles	H4.3
10	1	Graphical communication	H3.1, H4.3
10	1	Circuitry	113.1, 114.3

Section II

Question	Marks	Content	Syllabus outcomes
11	1	Electrical principles	H4.3, H6.1
12	2	Electrical principles	H4.3, H6.1
13	2	Electrical principles	H4.3, H6.1, H6.2
14	3	Electrical principles	H3.1, H4.3, H6.1
15	3	Circuitry	H3.1, H4.3
16	4	Processes, Circuitry	H1.2, H2.1, H3.1, H4.3, H6.2

Section III

Question	Marks	Content	Syllabus outcomes
17 (a)	5	Occupational health and safety	H1.1, H1.2
17 (b)	10	Occupational health and safety	H1.1, H1.2, H6.2, H7.1